

**$V_{DRM}$**  = 6000 V  
 **$I_{TGQM}$**  = 3000 A  
 **$I_{TSM}$**  = 24 kA  
 **$V_{TO}$**  = 1.70 V  
 **$r_T$**  = 0.60 mΩ  
 **$V_{DClin}$**  = 3800 V

# Gate turn-off Thyristor

# 5SGT 30J6004

Doc. No. 5SYA 1212-04 Aug. 2000

- Patented free-floating silicon technology
- Low on-state and switching losses
- Annular gate electrode
- Industry standard housing
- Cosmic radiation withstand rating

The 5SGT 30J6004 is an 85 mm buffered layer, Transparent Emitter (non-shorted anode) GTO with exceptionally low dynamic and static losses and gate drive requirements. Housed in an industry-standard 108 mm wide housing, it is ideally suited for high reliability applications such as Transportation and Medium Voltage Drives.

## Blocking

$V_{DRM}$	Repetitive peak off-state voltage	6000 V	$V_{GR} \geq 2V$
$V_{RRM}$	Repetitive peak reverse voltage	17 V	
$I_{DRM}$	Repetitive peak off-state current	$\leq 100$ mA	$V_D = V_{DRM}$ $V_{GR} \geq 2V$
$I_{RRM}$	Repetitive peak reverse current	$\leq 50$ mA	$V_R = V_{RRM}$ $R_{GK} = \infty$
$V_{DClink}$	Permanent DC voltage for 100 FIT failure rate	3800 V	-40 $\leq T_j \leq 110$ °C. Ambient cosmic radiation at sea level in open air.

## Mechanical data (see Fig. 19)

$F_m$	Mounting force	min.	36	kN
		max.	44	kN
A	Acceleration: Device unclamped Device clamped		50 200	m/s <sup>2</sup>
M	Weight		1.3	kg
$D_s$	Surface creepage distance	$\geq$	33	mm
$D_a$	Air strike distance	$\geq$	15	mm

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**GTO Data****On-state**

$I_{TAVM}$	Max. average on-state current	1030 A	Half sine wave, $T_C = 70^\circ C$			
$I_{TRMS}$	Max. RMS on-state current	1620 A				
$I_{TSM}$	Max. peak non-repetitive surge current	24 kA	$t_P = 10 \text{ ms}$	$T_j = 110^\circ C$	After surge: $V_D = V_R = 0V$	
		40 kA	$t_P = 1 \text{ ms}$			
$I^2t$	Limiting load integral	$2.88 \cdot 10^6 \text{ A}^2\text{s}$	$t_P = 10 \text{ ms}$	$T_j = 110^\circ C$		
		$0.80 \cdot 10^6 \text{ A}^2\text{s}$	$t_P = 1 \text{ ms}$			
$V_T$	On-state voltage	3.50 V	$I_T = 3000 \text{ A}$	$T_j = 110^\circ C$		
$V_{TO}$	Threshold voltage	1.70 V	$I_T = 400 - 4000 \text{ A}$			
$r_T$	Slope resistance	0.60 mΩ				
$I_H$	Holding current	100 A	$T_j = 25^\circ C$			

**Gate**

$V_{GT}$	Gate trigger voltage	1.2 V	$V_D = 24 \text{ V}$	$T_j = 25^\circ C$
$I_{GT}$	Gate trigger current	1.0 A	$R_A = 0.1 \Omega$	
$V_{GRM}$	Repetitive peak reverse voltage	17 V		
$I_{GRM}$	Repetitive peak reverse current	20 mA	$V_{GR} = V_{GRM}$	

**Turn-on switching**

$di/dt_{crit}$	Max. rate of rise of on-state current	400 A/μs	$f = 200 \text{ Hz}$	$I_T = 3000 \text{ A}, T_j = 110^\circ C$
		800 A/μs	$f = 1 \text{ Hz}$	$I_{GM} = 25 \text{ A}, di_G/dt = 25 \text{ A/μs}$
$t_d$	Delay time	2.5 μs	$V_D = 0.5 V_{DRM}$	$T_j = 110^\circ C$
$t_r$	Rise time	5.0 μs	$I_T = 3000 \text{ A}$	$di/dt = 300 \text{ A/μs}$
$t_{on(min)}$	Min. on-time	100 μs	$I_{GM} = 25 \text{ A}$	$di_G/dt = 25 \text{ A/μs}$
$E_{on}$	Turn-on energy per pulse	2.50 Ws	$C_s = 3 \mu\text{F}$	$R_s = 10 \Omega$

**Turn-off switching**

$I_{TGQM}$	Max controllable turn-off current	3000 A	$V_{DM} = V_{DRM}$	$di_{GQ}/dt = 70 \text{ A/μs}$
			$C_s = 3 \mu\text{F}$	$L_s \leq 0.2 \mu\text{H}$
$t_s$	Storage time	25.0 μs	$V_D = \frac{1}{2} V_{DRM}$	$V_{DM} = V_{DRM}$
$t_f$	Fall time	3.0 μs	$T_j = 110^\circ C$	$di_{GQ}/dt = 70 \text{ A/μs}$
$t_{off(min)}$	Min. off-time	100 μs	$I_{TGQ} = I_{TGQM}$	
$E_{off}$	Turn-off energy per pulse	16.0 Ws	$C_s = 3 \mu\text{F}$	$R_s = 10 \Omega$
$I_{GQM}$	Peak turn-off gate current	900 A	$L_s \leq 0.2 \mu\text{H}$	

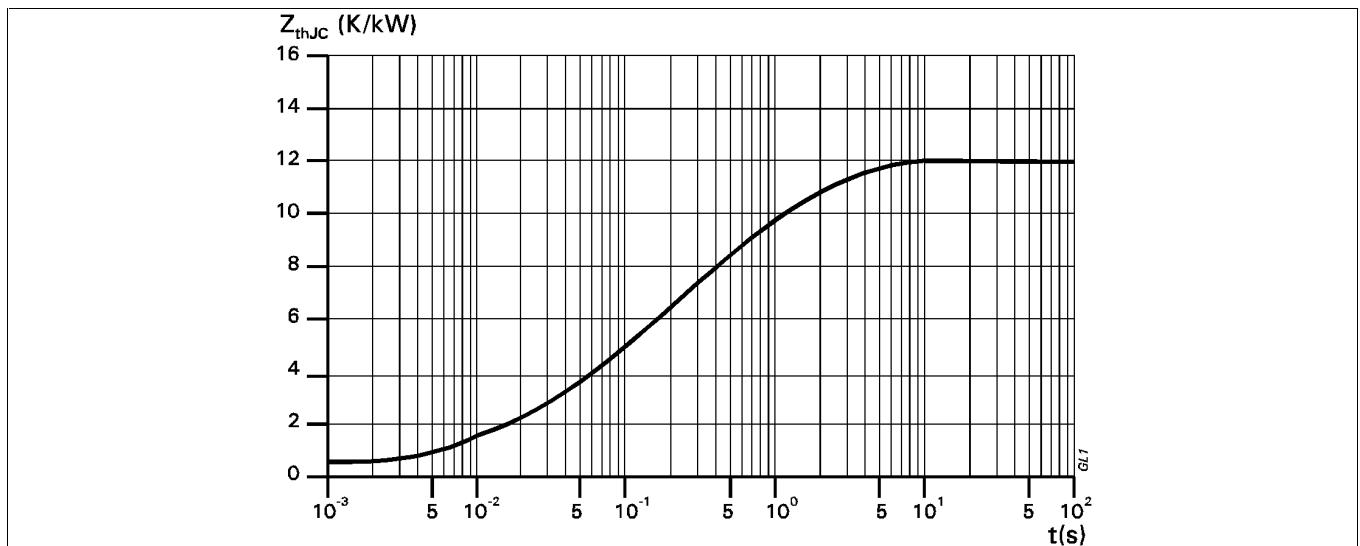
**Thermal**

$T_j$	Storage and operating junction temperature range	-40...110°C	
$R_{thJC}$	Thermal resistance junction to case	22 K/kW	Anode side cooled
		27 K/kW	Cathode side cooled
		12 K/kW	Double side cooled
$R_{thCH}$	Thermal resistance case to heat sink	6 K/kW	Single side cooled
		3 K/kW	Double side cooled

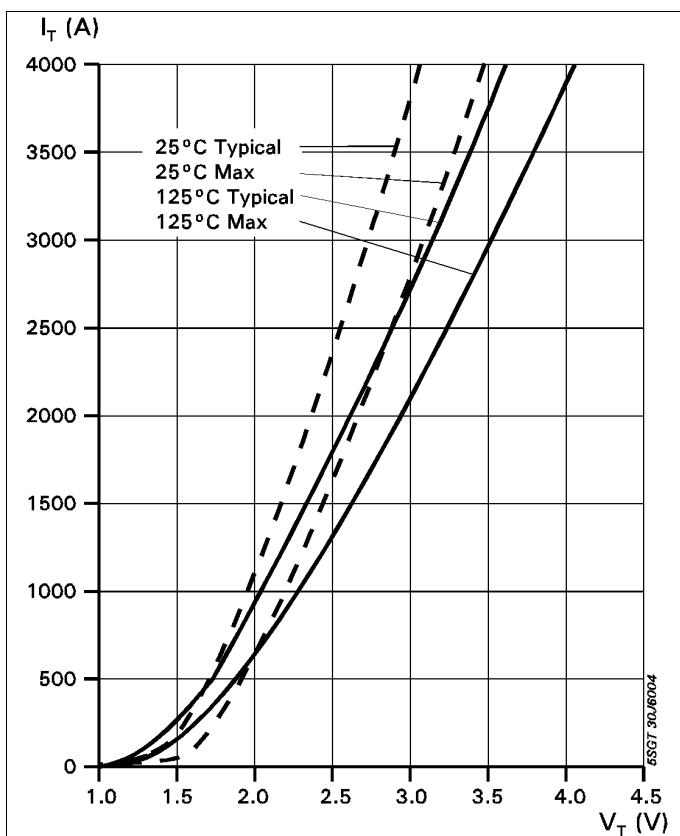
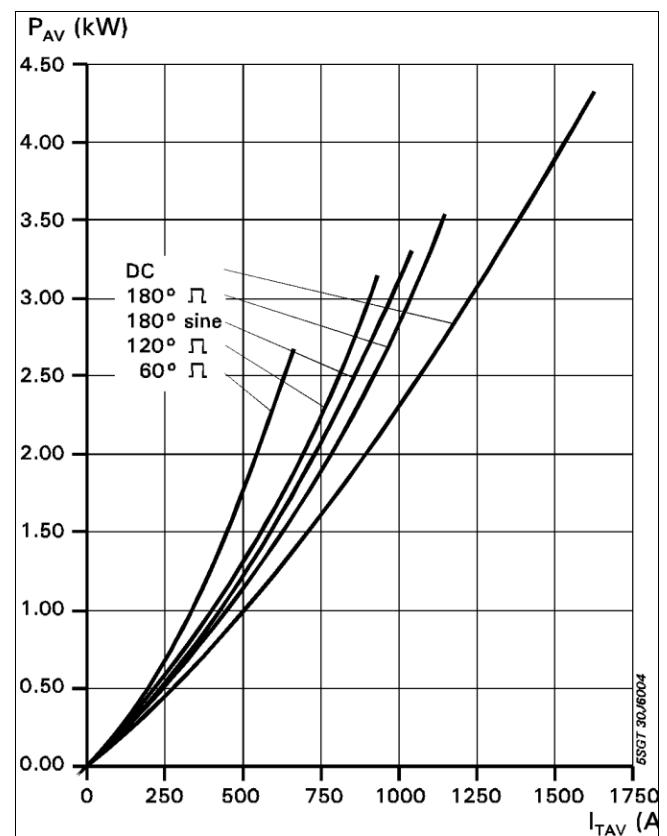
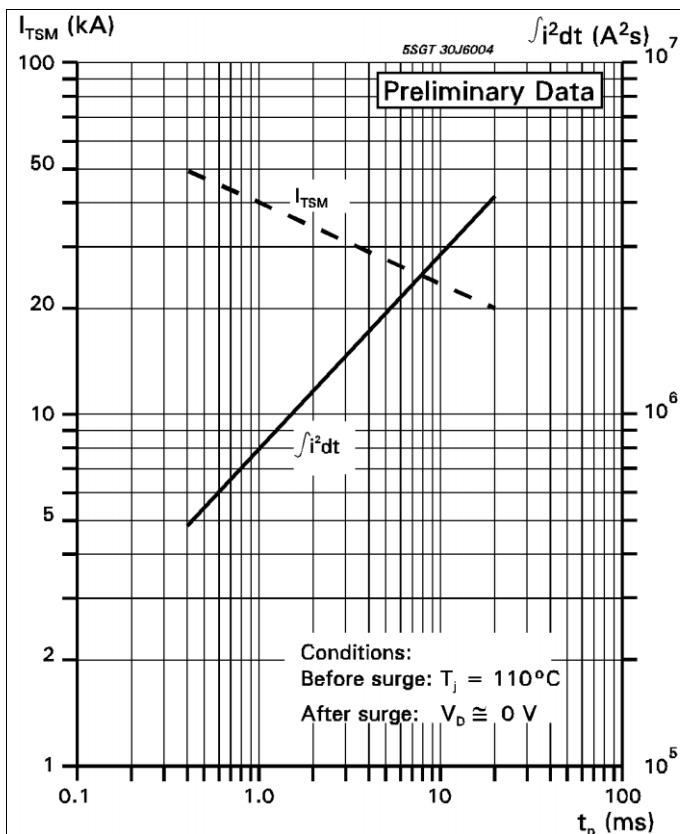
**Analytical function for transient thermal impedance:**

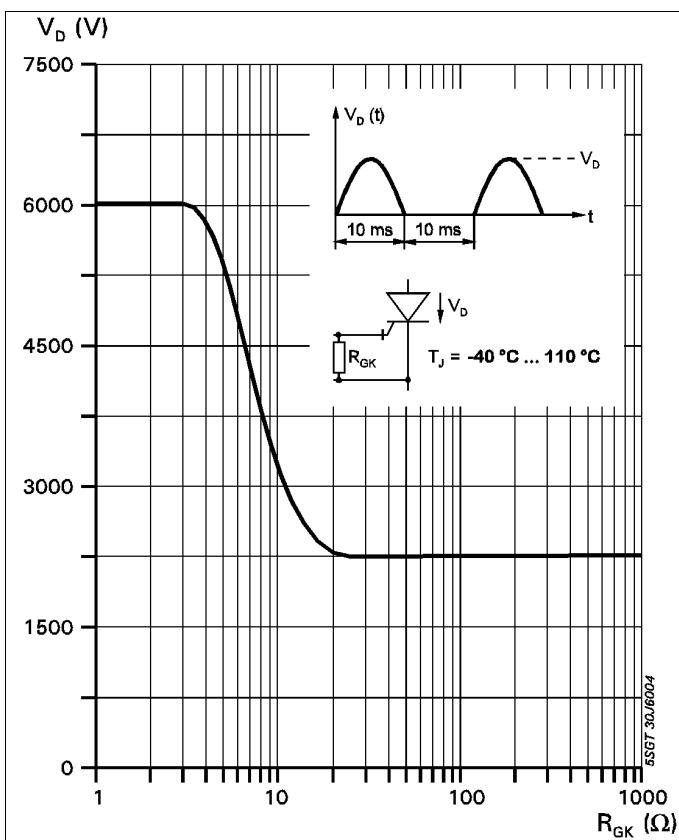
$$Z_{thJC}(t) = \sum_{i=1}^4 R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i$ (K/kW)	5.4	4.5	1.7	0.4
$\tau_i$ (s)	1.2	0.17	0.01	0.001

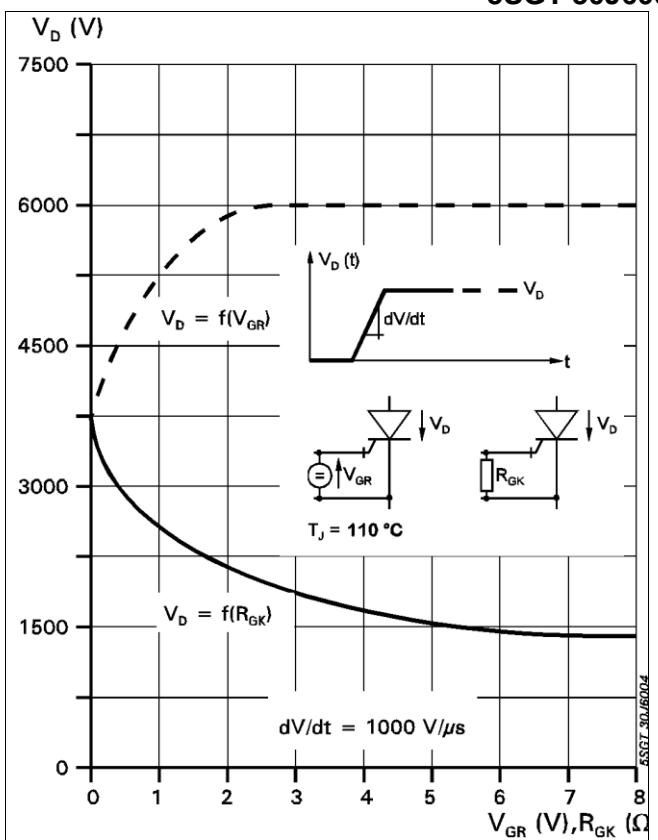


**Fig. 1** Transient thermal impedance, junction to case.

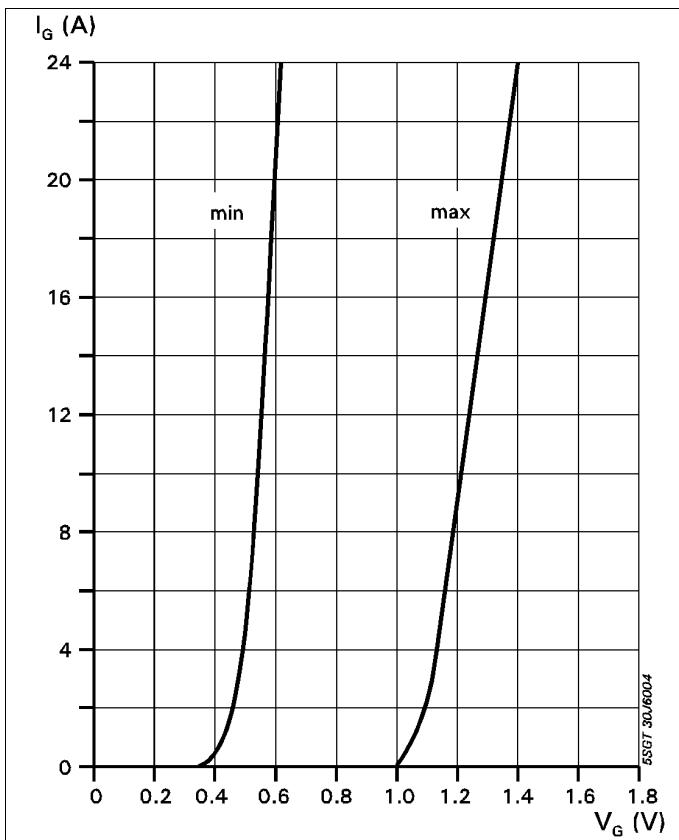
**Fig. 2** On-state characteristics**Fig. 3** Average on-state power dissipation vs. average on-state current.**Fig. 4** Surge current and fusing integral vs. pulse width



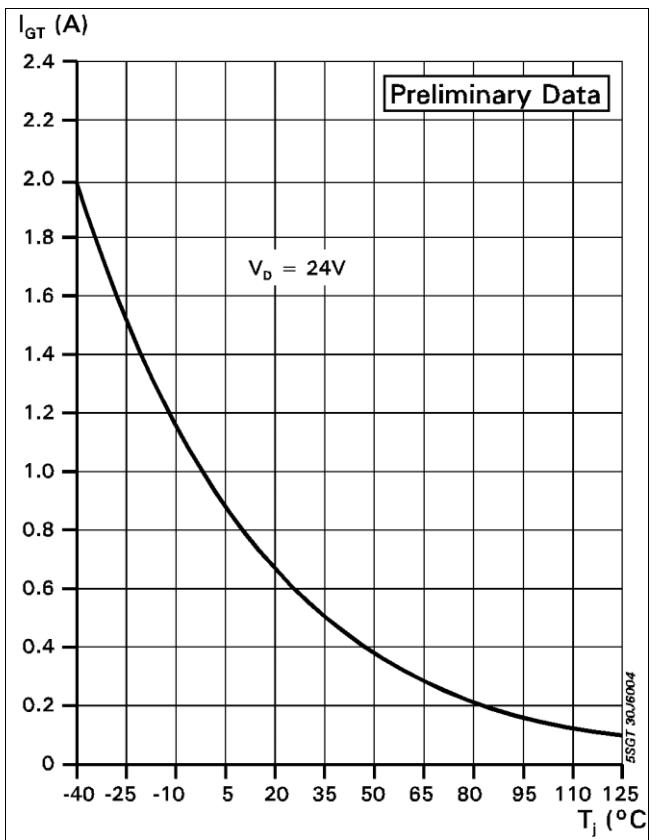
**Fig. 5** Forward blocking voltage vs. gate-cathode resistance.



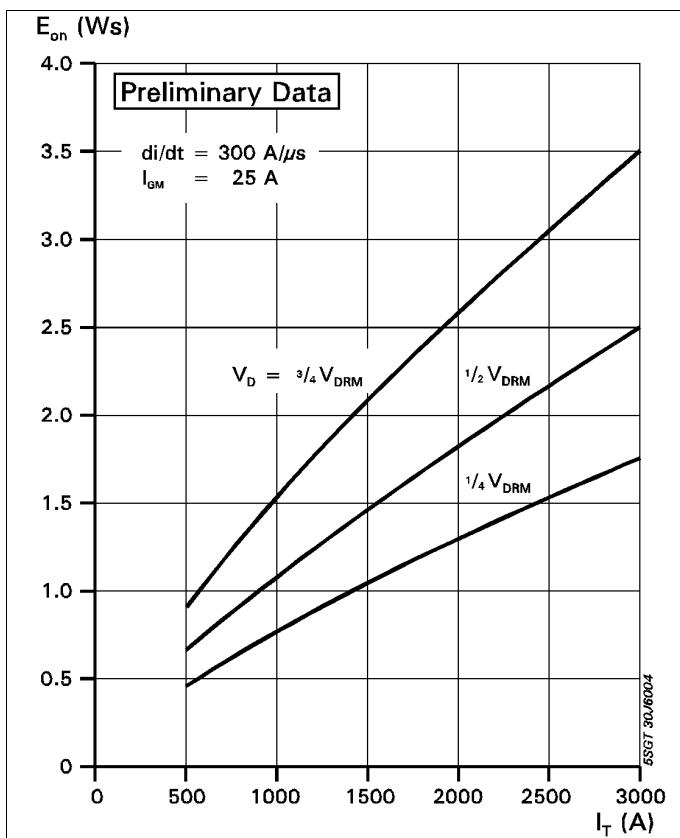
**Fig. 6** Static  $dv/dt$  capability: Forward blocking voltage vs. neg. gate voltage or gate cathode resistance.



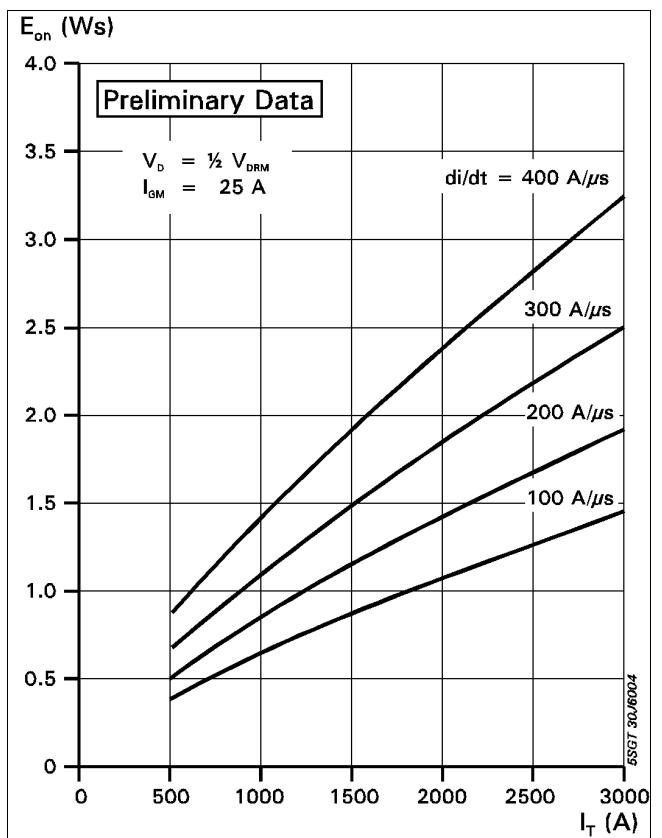
**Fig. 7** Forward gate current vs. forward gate voltage.



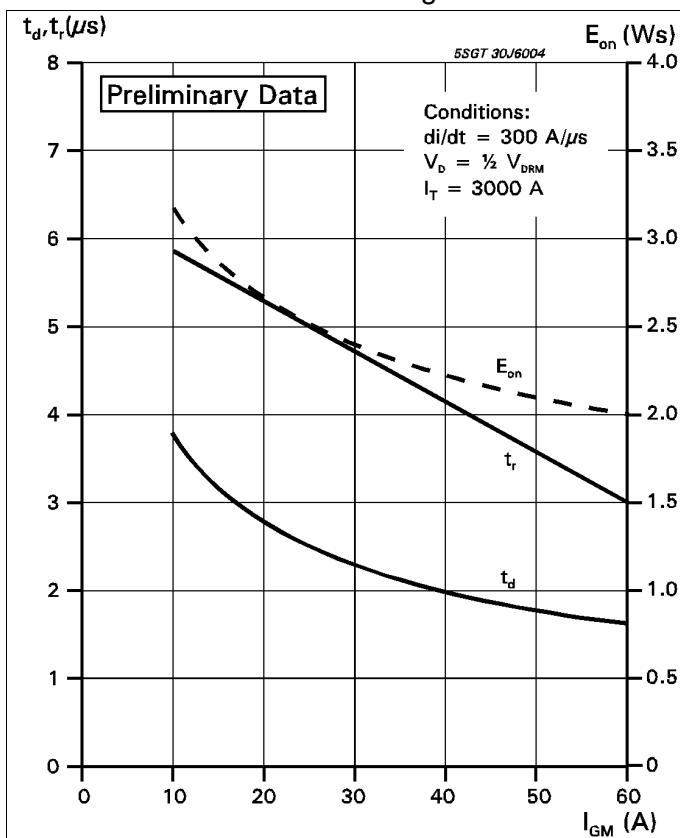
**Fig. 8** Gate trigger current vs. junction temperature



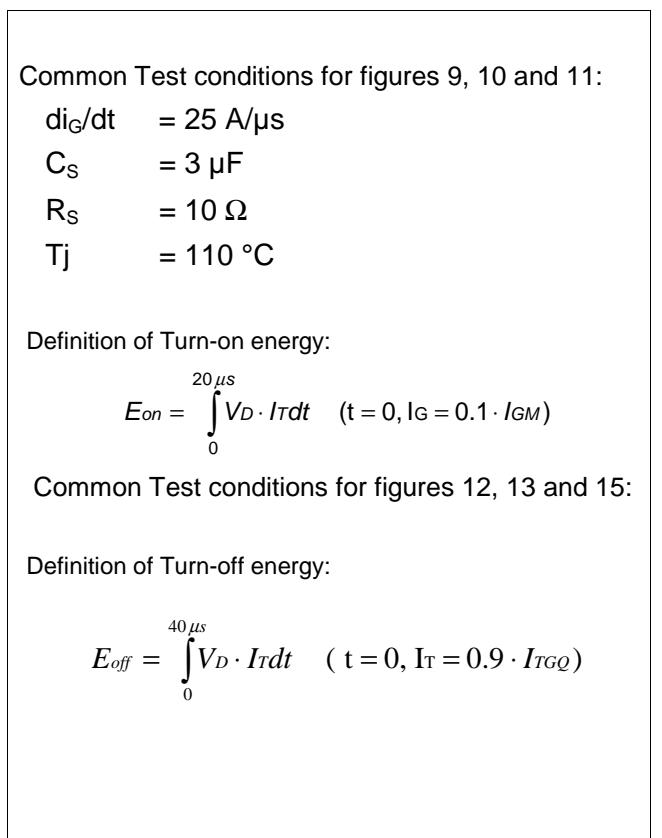
**Fig. 9** Turn-on energy per pulse vs. on-state current and turn-on voltage.

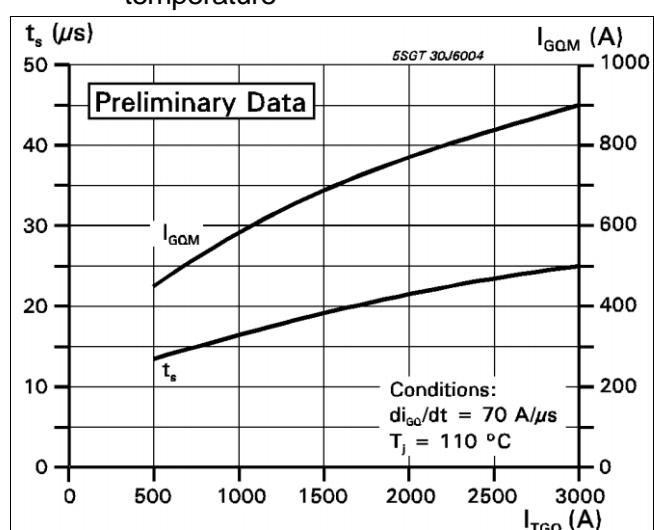
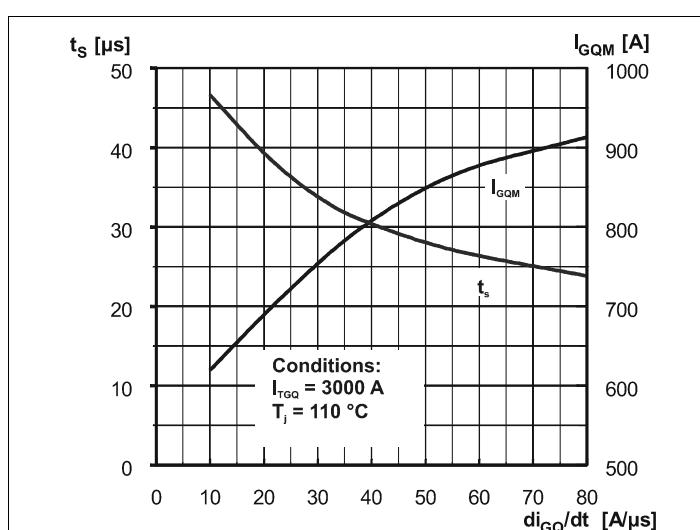
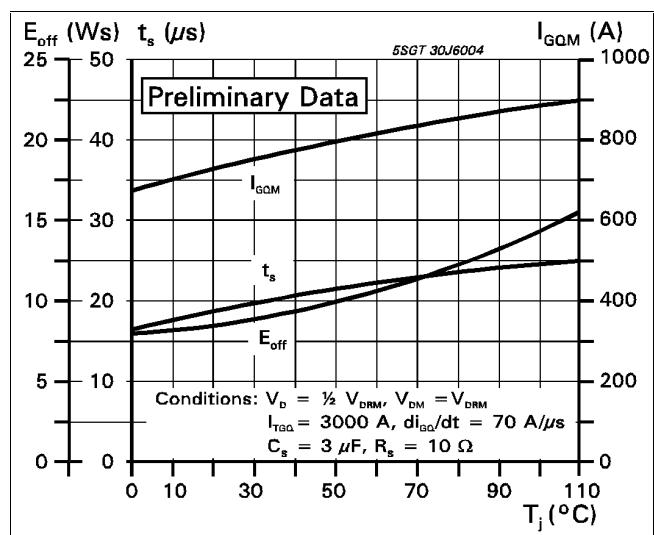
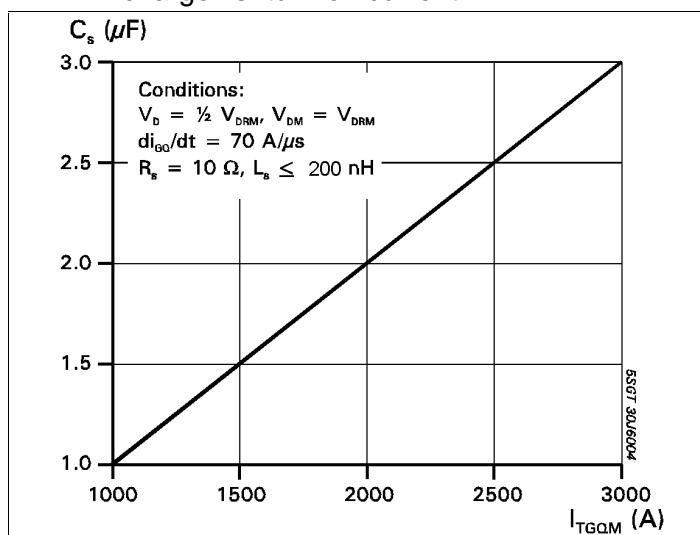
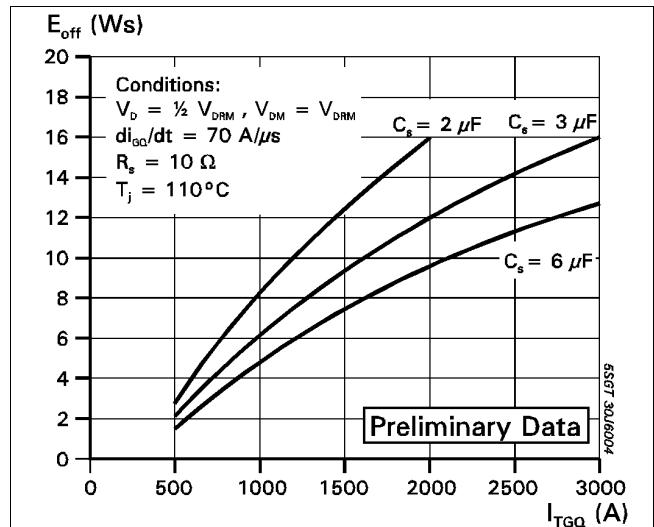
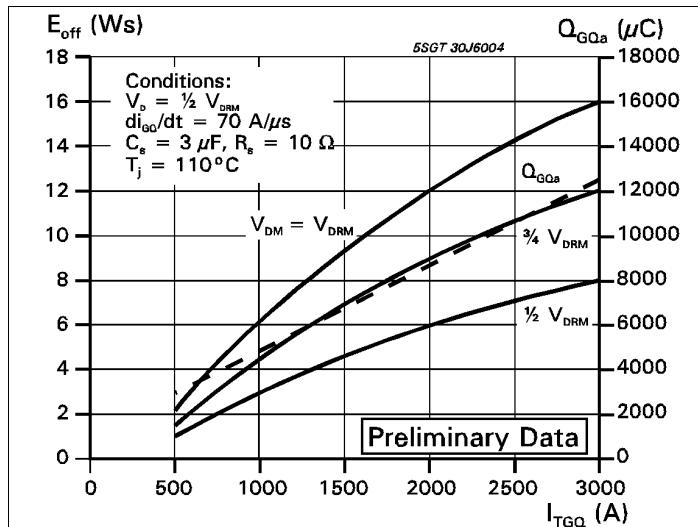


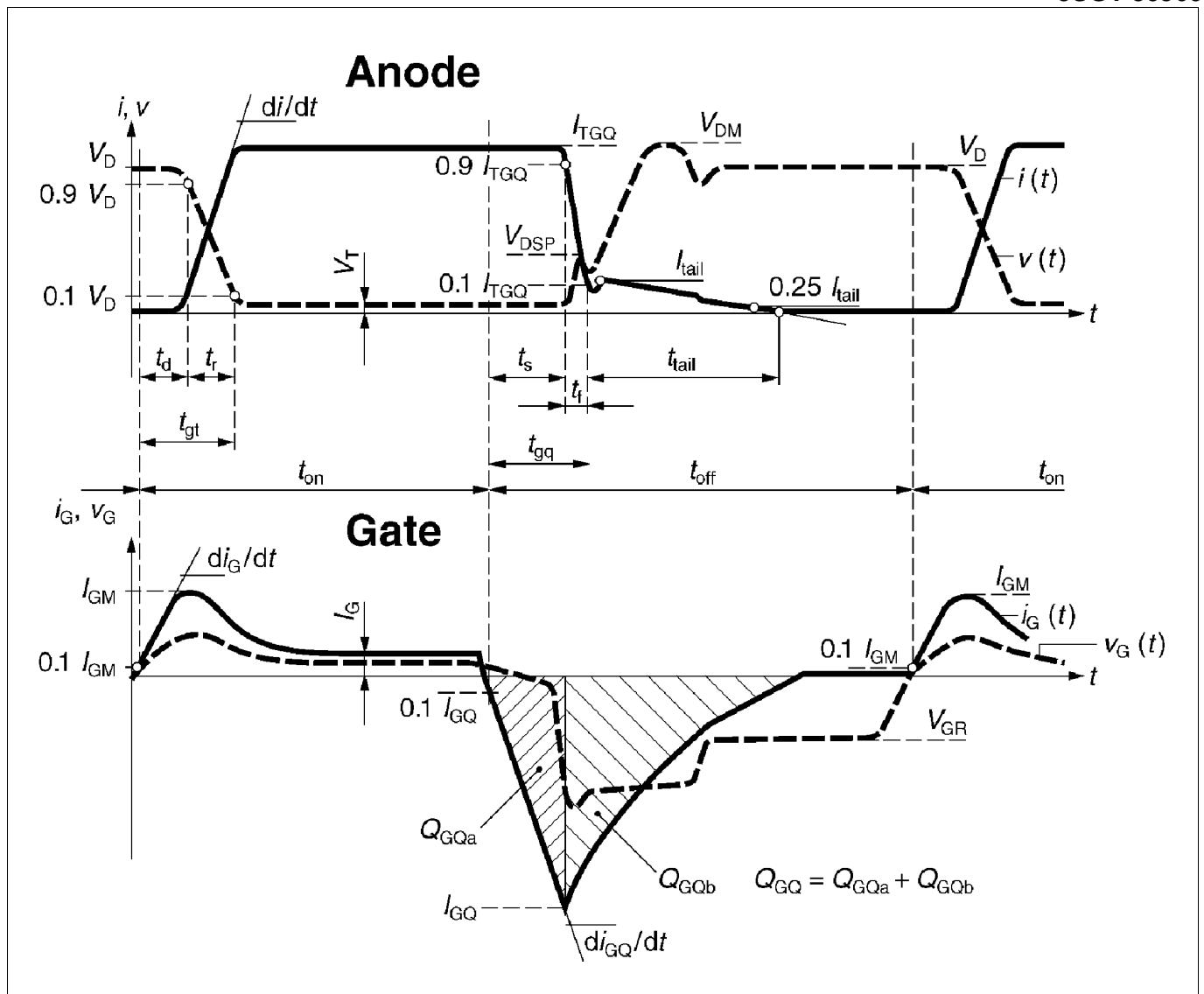
**Fig. 10** Turn-on energy per pulse vs. on-state current and current rise rate



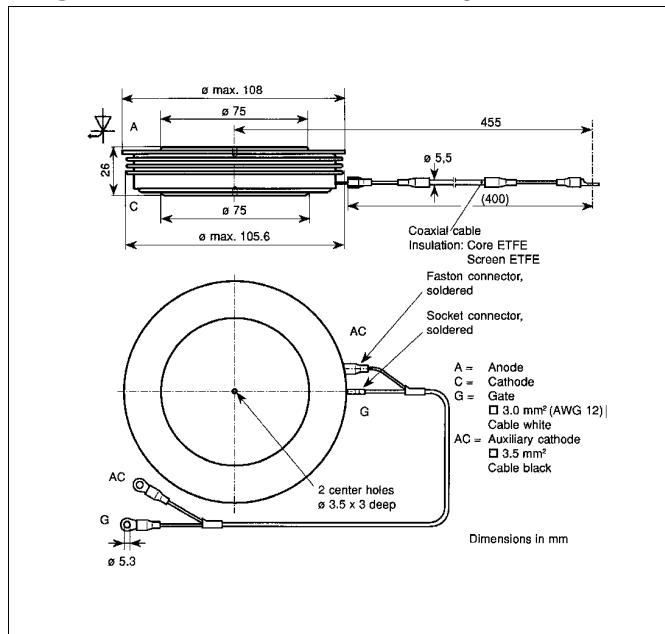
**Fig. 11** Turn-on energy per pulse vs. on-state current and turn-on voltage.







**Fig. 18** General current and voltage waveforms with GTO-specific symbols



**Fig. 19** Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

## Reverse avalanche capability

In operation with an antiparallel freewheeling diode, the GTO reverse voltage  $V_R$  may exceed the rated value  $V_{RRM}$  due to stray inductance and diode turn-on voltage spike at high  $di/dt$ . The GTO is then driven into reverse avalanche. This condition is not dangerous for the GTO provided avalanche time and current are below 10  $\mu s$  and 1000 A respectively. However, gate voltage must remain negative during this time. Recommendation :  $V_{GR} = 10... 15$  V.

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